附件 3：赛项报名汇总表

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| 2023一带一路暨金砖国家技能发展与技术创新大赛 | | | | | | | | |
| 集成电路设计与应用赛项参赛报名统计汇总表 | | | | | | | | |
| **序号** | **学校名称** | **参赛赛道** | **队伍名称** | **参赛选手1** | **参赛选手2** | **参赛选手3** | **指导教师姓名** | **联系方式** |
| 1 |  |  |  |  |  |  |  |  |
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| 12 |  |  |  |  |  |  |  |  |
| 13 |  |  |  |  |  |  |  |  |
| 14 |  |  |  |  |  |  |  |  |
| 15 |  |  |  |  |  |  |  |  |